

NORTH AMERICA PRINTED CIRCUIT BOARD (PCB) MARKET FORECAST 2017-2025

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Abstracts

KEY FINDINGS

The revenue generated by the North America Printed Circuit Board market is predicted to scale up from \$2989 million in 2016 to \$3376 million by the end of 2025, witnessing a CAGR of 1.36% over the forecast period of 2017-2025.

MARKET INSIGHTS

The North American market is regionally segmented into the US and Canada. The U.S market is presently reigning the North American region due to growing deployment of PCB's in consumer electronics products like Smartphones, PCs, and Tablets. The region has also witnessed a rising demand for smart surveillance cameras which in turn has strengthened the demand for PCB market in the country. The Canadian market is also fast growing. The expanding consumer electronics segment is mainly responsible for driving the market growth.

COMPETITIVE INSIGHTS

Tripod Technology Corporation, Ascent Circuit Private Limited, Samsung Electronics Inc, TTM Technologies, Hewlett-Packard Company, AT&S, Isu Petasys, Nippon Mektron Ltd, Hannstar Board Technology, Ibiden Inc, Shennan Circuits, Young Poong Electronics Co. Ltd, Zhen Ding Technology Holding Ltd, Epitome Components Ltd, Compeq Ltd, Unimicron Technology Corp and Daeduck Electronics are few of the noted companies in this market.

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COMPANIES MENTIONED

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2. AT&S
3. COMPEQ LTD
4. DAEDUCK ELECTRONICS
5. EPITOME COMPONENTS LTD.
6. HANNSTAR BOARD TECHNOLOGY
7. HEWLETT-PACKARD COMPANY
8. IBIDEN INC.
9. ISU PETASYS
10. NANYA PCB INC
11. NIPPON MEKTRON, LTD.
12. OKI PRINTED CIRCUITS CO. LTD.
13. SAMSUNG ELECTRONICS INC
14. SHENNAN CIRCUITS
15. TRIPOD TECHNOLOGY CORPORATION
16. TTM TECHNOLOGIES
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